View Article Online

CrystEngComm

Accepted Manuscript

This article can be cited before page numbers have been issued, to do this please use: A. Sarikov, A. Marzegalli, L. Barbisan, M. Zimbone, C. Bongiorno, M. Mauceri, D. Crippa, F. La Via and L. Miglio, *CrystEngComm*, 2021, DOI: 10.1039/D0CE01613F.



This is an Accepted Manuscript, which has been through the Royal Society of Chemistry peer review process and has been accepted for publication.

Accepted Manuscripts are published online shortly after acceptance, before technical editing, formatting and proof reading. Using this free service, authors can make their results available to the community, in citable form, before we publish the edited article. We will replace this Accepted Manuscript with the edited and formatted Advance Article as soon as it is available.

You can find more information about Accepted Manuscripts in the Information for Authors.

Please note that technical editing may introduce minor changes to the text and/or graphics, which may alter content. The journal's standard <u>Terms & Conditions</u> and the <u>Ethical guidelines</u> still apply. In no event shall the Royal Society of Chemistry be held responsible for any errors or omissions in this Accepted Manuscript or any consequences arising from the use of any information it contains.



rsc.li/crystengcomm

ARTICLE

Received 00th January 20xx, Accepted 00th January 20xx

DOI: 10.1039/x0xx00000x

Mechanism of stacking fault annihilation in 3C-SiC epitaxially grown on Si(001) by molecular dynamics simulations

Andrey Sarikov,^{*a, b} Anna Marzegalli,^c Luca Barbisan,^a Massimo Zimbone,^d Corrado Bongiorno,^e Marco Mauceri,^f Danilo Crippa,^g Francesco La Via ^e and Leo Miglio ^a

In this work, annihilation mechanism of stacking faults (SFs) in epitaxial 3C-SiC layers grown on Si(001) substrates is studied by molecular dynamics (MD) simulations. The evolution of SFs located in the crossing ($\overline{1}11$) and ($1\overline{1}1$) glide planes is considered. This evolution is determined by the interaction of 30° leading partial dislocations (PDs) limiting the stacking faults, under the slightly compressive (~ 0.45 %) strain condition during 3C-SiC layer growth. It is characterized in key terms: the distance between the PDs and the mutual orientation of their Burgers vectors. Two SF annihilation scenarios are revealed, namely: (i) the PDs with opposite screw components of their Burgers vectors, leading the SFs located in the ($\overline{1}11$) and ($1\overline{1}1$) planes, are close enough (~ 15 nm or less) and attract each other, in this case, the propagation of both SFs is suppressed with the formation of a Lomer-Cottrell lock at their intersection, and (ii) two PDs are far away one from the other (beyond ~ 15 nm) and do not interact, or they repulse each other having equal screw components of their Burgers vectors, in this case the propagation of only one of the SFs is suppressed. Obtained results explain the mechanism of SF annihilation and formation of SF intersection patterns observed experimentally by TEM investigations. They will provide important implications for the elaboration of advanced methods for the reduction of SF concentrations in epitaxial 3C-SiC layers on Si substrates.

Introduction

Published on 04 January 2021. Downloaded by Universita di Catania on 1/7/2021 5:22:10 PM

Cubic silicon carbide (3C-SiC) layers epitaxially grown on Si(001) substrates are promising for manufacture of high power and high frequency electronic devices.¹⁻⁵ However, such layers abound in extended defects mostly resulted from about 19.7 % lattice mismatch between the dissimilar epi-layer and substrate materials.⁶ Stacking faults (SFs) belong to the most important ones dominating over entire 3C-SiC layer thickness and causing degradation of electrical performance 7 by accumulation of dopants 8 or due to recombination levels introduced by SF terminating partial dislocation (PD) complexes.⁹ Unlike other types of extended defects, stacking faults cannot be eliminated completely by mutual annihilation even in very thick 3C-SiC layers due to concurrent SF generation.¹⁰⁻¹² The minimum SF densities achieved so far for 3C-SiC grown on flat Si(001) substrates amount to about 10⁴ cm⁻¹.¹³ Specific substrate patterning such as undulation,14,15 inverted pyramidal structuring^{16,17} and deep profiling in the form or ridges or

^{g.} LPE S.p.A, via Falzarego 8, 20021 Baranzate, Italy

pillars^{18,19} were proposed to reduce this value. Nevertheless, 3C-SiC layers with acceptably lower SF concentrations still remain a challenging goal.

SF elimination may take place by mutual annihilation mechanism,^{10,20} i. e. the propagation of stacking faults lying in opposite {111} planes is suppressed upon their intersection. This suppression is achieved by a formation of a Lomer-Cottrell lock by two Shockley partial dislocations that lead the SFs, or by locking of gliding of a SF leading PD upon encountering the crossing stacking fault.^{13,21} This mechanism requires a deeper comprehension as related to the conditions of 3C-SiC epi-layer growth and the characteristics of stacking faults and terminating them partial dislocations.

In this work, we use molecular dynamics (MD) simulations to determine the main factors governing the suppression of SF propagation and the formation of SF intersection patterns in 3C-SiC layers grown on Si(001) substrates. Based on the obtained results, we characterize the SF annihilation mechanism in key terms: stress in the 3C-SiC layers at different growth stages as well as mutual arrangement and orientations of the Burgers vectors of SF leading partial dislocations.

Methods

3C-SiC layers were grown hetero-epitaxially on 4-inch 650 μm thick Si(001) substrates using chemical vapor deposition, in a horizontal hot-wall reactor. Prior to the layer growth, Si substrates underwent

^{a.} L-NESS and Department of Materials Science, University of Milano-Bicocca, via R. Cozzi 55, 20125 Milan, Italy

^{b.} V. Lashkarev Institute of Semiconductor Physics NAS Ukraine, 45 Nauki avenue, 03028 Kyiv, Ukraine

^c L-NESS and Department of Physics, Politecnico di Milano, via Anzani 42, 22100 Como, Italy

^{d.} IMM-CNR, via S. Sofia 24, 95128 Catania, Italy

^{e.} IMM-CNR, VIII Strada 5, 95121 Catania, Italy

F LPE, Sedicesima Strada, Zona Industriale, Blocco Torre Allegra, 95121 Catania, Italy

CrystEngComm

ARTICLE

Published on 04 January 2021. Downloaded by Universita di Catania on 1/7/2021 5:22:10 PM

an etching and carbonization step performed at 1100°C by introducing H₂ and H₂ plus ethylene (C₂H₄) for the former and the latter process, respectively. Following carbonization, the temperature was ramped up to 1370°C and the growth took place at 10⁴ Pa under C/Si ratio of 0.8. The gases used during the growth were trichlorosilane and ethylene as silicon and carbon precursors, respectively, and H₂ as carrier gas. The final 3C-SiC thickness was 30 μ m. The defect structure was analyzed using high angle annular dark field scanning transmission electron microscopy (HAAD-STEM) carried out on a JEOL 2010F microscope. The studied samples were slightly tilted (1 to 2 degrees) in the (002) direction, which enabled higher contrast of SF visualization.

MD simulations were performed by the Large-scale Atomic/Molecular Massively Parallel Simulator (LAMMPS)²² in the canonical ensemble (NVT), using a Nose-Hoover thermostat regime. The atom interactions in 3C-SiC phase were described by the Vashishta potential.²³ This potential reliably predicts the evolution of extended defects in 3C-SiC and provides non-zero stacking fault energy due to the account of atom interactions beyond the first coordination sphere.²⁴ Analyses of defect configurations obtained at various time steps were performed using the Open Visualization Tool (OVITO) software.²⁵

Simulation cell was composed as an orthogonal box defined by the vectors $[1\overline{10}]$, [110] and [001] in the directions *X*, *Y* and *Z*, respectively. The dimensions of the box with 86400 atoms, 281.6 × 12.4 × 240.2 Å³, ensured an optimum balance between the computational cost and the accuracy of the description of considered defects. Periodic boundary conditions were applied in the *X* and *Y* directions to model the infinite 3C-SiC slab, while free surface condition was set in the *Z* direction. Moreover, bottom atomic rows were fixed during the simulations to model the effect of a thick Si substrate on the 3C-SiC epi-layer.²¹

Stacking faults were formed in the simulation cell by inserting pairs of Shockley partial dislocations limiting them. PDs were inserted parallel to the Y axis by shifting all the simulation cell atoms by the displacement vectors calculated in the framework of the dislocation theory²⁶ and additionally corrected to account for the infinite dislocation arrays created by the periodic boundary condition along the X axis.^{9,26,27}

MD simulations were performed with the time step of 0.3 fs at the thermostat temperature of 1800 K. Thermal dilation of the 3C-SiC layer corresponding to this temperature was accounted for by scaling up the cell dimensions by the factor obtained from the 3C-SiC bulk cell simulations in the NPT ensemble using the Nose-Hoover barostat regime.

Results and discussion

Fig. 1 shows a low magnification cross-section TEM image of the epitaxial 3C-SiC layer observed in the (110) projection plane. This image is taken at the distance exceeding 1 μ m from the 3C-SiC interface, so that the SF density turns to be sufficiently low and isolated SF intersections can be observed.¹¹ The SFs lying in the ($\overline{111}$) and ($1\overline{11}$) glide planes and extending in the direction bottom-top of the 3C-SiC layer are individuated as the white lines tilted by about 35° with respect to the layer growth direction [001].

Upon intersection, these stacking faults form "inverted $M_{icl}^{\prime\prime} \mathcal{O}_{Dn}^{\prime\prime} \mathcal{M}_{e}^{\prime\prime}$ patterns corresponding to complete or partial SF3 AnAfrication, respectively. It should be noted that other SF intersections may be also observed in the 3C-SiC epi-layers related to SF generation, which are not considered in this paper.



Fig. 1. Low-magnification TEM image of the 3C-SiC layer epitaxially grown on Si(001) substrate. [001] is the growth direction. Stacking faults appear as the white lines. Marked areas 1 and 2 show the "inverted V" and " λ "-shaped stacking fault intersections.

The stacking faults shown in Fig. 1 may contain various numbers of faulted atomic lattice planes. Their evolution, however, is determined by the intrinsic stacking faults composing them, i. e. the SFs consisting of only one faulted plane.²⁸

We consider the evolution of intrinsic SFs as a result of the motion of Shockley partial dislocations terminating them, due to the stress in 3C-SiC at different stages of the layer growth. Carbonization step prior to the 3C-SiC deposition is intended to convert the upper part of a Si substrate into thin 3C-SiC film with accommodation of the lattice mismatch between the two materials.^{10,13} At this stage, the major part of the misfit tensile strain resulted from about 4:5 ratio of the 3C-SiC and Si lattice constants, is released by a formation of Lomer dislocations on every five 3C-SiC planes on an average at the 3C-SiC/Si substrate interface.²⁹ Such interface structuring, however, is still insufficient to accommodate all the tensile strain in the 3C-SiC film as may be inferred from the temperature dependences of the 3C-SiC and Si lattice constants.^{30,31} Further strain is released by a generation of perfect glide dislocations with the Burgers vectors $\mathbf{b} = \frac{\ddot{z}}{2} \langle 011 \rangle$, which dissociate into Shockley partial pairs with $\mathbf{b} = \frac{a}{6} \langle 121 \rangle$, forming 30° and 90° angles with their dislocation lines and separated by stacking faults as a result of dislocation energy minimization.³² Under tensile strain condition during carbonization step, the leading 90° PDs are driven toward the 3C-SiC/Si interface and are anchored there, while the trailing 30° ones remain closer to the 3C-SiC layer surface leaving numerous stacking faults extending in the 3C-SiC layer bulk observed experimentally.²¹

Raise of the temperature for 3C-SiC deposition after carbonization turns the relaxed 3C-SiC layer to slightly compressive strain condition (about 0.45 %) as follows again from the Published on 04 January 2021. Downloaded by Universita di Catania on 1/7/2021 5:22:10 PM

as reported in Ref. 21.

CrystEngComm

temperature dependences of the 3C-SiC and Si lattice constants.^{30,31} Relaxation of compressive strain becomes led by 30° partials,³³ which should be expelled toward the free 3C-SiC surface leaving extending stacking faults behind. Interaction of gliding in opposite {111} planes (such as ($\overline{1}11$) and ($1\overline{1}1$)) 30° PDs each with other or with crossing SFs should lead to the formation of the "inverted V" or " λ " intersection patterns of stacking faults and to the suppression of propagation of the latter observed experimentally.

Molecular dynamics simulations are an efficient tool to study dynamics of the processes that cannot be explicitly observed experimentally, including the motion and interaction of partial dislocations. However, because of the use of empirical potentials fitted for limited sets of material characteristics, MD simulations cannot be regarded as universally applied or quantitatively precise. The choice of the most suitable potential for particular task is often required. In our previous publication,²⁴ we have validated the reliability of the dislocation dynamics in 3C-SiC layers with Vashishta potential. Therefore, we treat the results on the mechanisms of dislocation motion and interaction, obtained in this work, with high confidence. At the same time, however, the numerical values characterizing the processes under study remain potential dependent and may deviate to some extent from the respective real values.

To simulate the SF evolution resulted from the gliding and interaction of leading 30° partial dislocations under compressive strain condition, pairs of Shockley partials, each pair consisting of 30° and 90° PDs, were inserted in the glide set of the $(\overline{1}11)$ and $(1\overline{1}1)$ planes of the simulation cell. The 90° partials were placed close to the cell bottom in the region of immobile atoms to model their experimentally observed trapped state at the 3C-SiC/Si substrate interface during the 3C-SiC layer growth.²¹ The 30° partials separated from their 90° counterparts by stacking faults, were placed in the 3C-SiC bulk at various distances from the simulation cell bottom to model various mutual arrangements of SFs and leading PDs. The dimensions of the cell were scaled so to ensure compressive strain along the X and Y directions at the simulation temperature. In our MD simulations, the average compressive strain of 1.2 % instead of experimental value of ~ 0.45 % was applied. It was recalculated so to ensure a proper balance between the Peach-Koehler force acting on the leading dislocations, and the increased attractive force within the 30°-90° partial pairs due to the SF energy overestimation by the Vashishta potential $(12.09 \text{ meV/Å}^{224} \text{ vs } 2.51 \text{ meV/Å}^{2} \text{ obtained by DFT calculations}^{34}).$

Fig. 2 depicts the MD simulation results on the formation of "inverted V" intersection pattern, in which the annihilation of both participating SFs is apparent. In this case, two 30° SF leading PDs with opposite screw components of Burgers vectors interact attractively according to the reaction: $\frac{a}{6}[\overline{12}1] + \frac{a}{6}[21\overline{1}] \rightarrow \frac{a}{6}[1\overline{10}]$ (or, alternatively, $\frac{a}{6}[211] + \frac{a}{6}[\overline{12}1] \rightarrow \frac{a}{6}[1\overline{10}]$. Dislocation attraction takes an effect at the distances not exceeding the interaction radius equal approximately to 15 nm, according to our MD simulations. As noted above, although MD simulations unambiguously point to the existence of the maximum radius for dislocation interaction, its value should be regarded as potential dependent and subject to some deviation from the real value. Resulting stable dislocation complex formed at the SF intersection is the Lomer-Cottrell lock dislocation evidenced by a six-member ring of atoms (see Fig. 2 c)



Fig. 2. MD simulation snapshots of the formation of "inverted V"-shaped intersection of stacking faults in 3C-SiC epi-layers on Si(001) substrates by the interaction of leading 30° partial dislocations with opposite screw components of Burgers vectors. Simulation time: a - 0, b - 120 ps, and c - 180 ps. Blue atoms correspond to the Si and C atoms in the cubic diamond lattice, orange atoms belong to the stacking faults. Inset in panel (c) shows the atomic configuration of the formed Lomer-Cottrell lock dislocation.

Fig. 3 shows two pathways of the formation of " λ "-type SF intersections. In the first case shown in panels (a) to (c), the SF leading partial dislocations do not interact efficiently and propagate independently because of the distance between them exceeding the interaction radius. The "rear" PD gliding in the (111) plane, stops upon encountering the stacking fault left behind by the "advanced" PD in the (111) plane. In view of the independence of the motion of both dislocations, the relation between their Burgers vectors is not important: the exclusion of one SF from further propagation is the same for both equal and opposite orientations of the screw components of the dislocation Burgers vectors. The atomic configuration of the SF intersection is shown in the inset of Fig. 3 c.

An alternative pathway for the formation of the " λ "-shaped SF intersection is presented in the panels (d) to (f) of Fig. 3. In this case, closely spaced (within the interaction radius) 30° PDs with equal screw components of their Burgers vectors repulse each other. For better illustration of repulsion and impossibility to maintain a stable complex together, the dislocations were placed initially at the same point in Fig. 3 d. As a result, one PD advances (in our case, the one lying in the (111) plane) leaving a stacking fault behind, while the other one (in the (111) plane) encounters it and stops from further gliding. The atomic configuration of the intersection junction coincides with the one presented in the inset of Fig. 3 c.

Results of MD simulations demonstrate that the formation of SF intersection patterns in 3C-SiC layers is determined by the gliding of 30° partial dislocations terminating the SFs. This gliding takes place under action of three forces, two of them driving

View Article Online

CrystEngComm

the 30° PDs toward the free 3C-SiC layer surface and the rest one holding them back.²⁶ The former are represented by the image force, attracting the dislocations to the free surface independently on the Burgers vectors orientations, and the Peach-Koehler force, which acts on the 30° partials under consideration in the upward direction to release compressive strain in the 3C-SiC layers induced by the deposition process. The third force originates from the tendency to decrease the positive energy of stacking faults formed within the 30°-90° dislocation pairs; it attracts 30° and 90° partials toward each other and, hence, hinders the 30° partial forward gliding. As a result, 30° PDs tend to be expelled to the 3C-SiC free surface leaving the stacking faults in the layer bulk. Having encountered a crossing stacking fault, a 30° dislocation is suppressed from further gliding due to the disconnection of its slip plane at the intersection junction, as shown by the inset of Fig. 3 c.



Fig. 3. MD simulation snapshots of the formation of " λ "-shaped intersections of stacking faults in 3C-SiC epi-layers on Si(001) substrates in the case of the large distance between the 30° leading dislocations (a-c) and as a result of the interaction of closely spaced 30° dislocations with equal screw components of Burgers vectors (d-f). Simulation time: a – 0, b – 360 ps, c – 540 ps, and d – 0, e – 60 ps, f – 200 ps. Blue atoms correspond to the Si and C atoms in the cubic diamond lattice, orange atoms belong to the stacking faults. Inset in panel (c) shows the atomic configuration of the intersection of 30° partial dislocation with crossing stacking fault, also corresponding to the intersection in panel (f).

Moreover, the closer are the 30° partial dislocations, gliding in the $(\overline{1}11)$ and $(1\overline{1}1)$ planes, the more significant becomes the interaction force between them. According to our MD simulations, this force dominates the motion of partial dislocations

at the distances not exceeding about 15 nm. This force may be attractive or repulsive depending on whether the distocation stress fields attenuate or amplify each other. In particular, dislocations with opposite screw components of Burgers vectors, gliding in the $(\overline{1}11)$ and $(1\overline{1}1)$ planes, attract each other forming together Lomer-Cottrell lock dislocation as shown in Fig. 2. From the proportionality of the dislocation energy to the square of its Burgers vector, $\mathbf{b}^{2,26}$ the formation of Lomer-Cottrell lock with $\mathbf{b} = \frac{1}{6} \langle 011 \rangle$ instead of two Shockley PDs with $\mathbf{b} = \frac{a}{6} \langle 121 \rangle$ must lead to a decrease of the crystal elastic energy. Such a decrease is indeed obtained in our MD simulations, as visualized by the elastic energy maps in Fig. 4 a and b for the configurations of Fig. 2 a and c, respectively. In these images, the zero energy point corresponds to the defect free compressed 3C-SiC crystal at the simulation temperature. We stress once again that such a process is the most efficient from the point of view of the reduction of SF concentration in the 3C-SiC layers since two stacking faults are excluded from further extension.



Fig. 4. Elastic energy maps corresponding to the interaction of closely spaced 30° partial dislocations with opposite (a and b) and equal (c and d) screw components of Burgers vectors in the initial (a and c) and final (b and d) states of evolution.

On the contrary, 30° PDs with equal screw components of their Burgers vectors, gliding in the $(\overline{1}11)$ and $(1\overline{1}1)$ planes, would combine their Burgers vectors as $\frac{a}{6}[\overline{12}1] + \frac{a}{6}[\overline{12}1] \rightarrow \frac{a}{3}[\overline{12}0]$ (or $\frac{a}{6}$ [211] $+ \frac{a}{6}[21\overline{1}] \rightarrow \frac{a}{3}[210]$). Using again the **b**² criterion, we conclude these reactions to be unfavorable as increasing the elastic energy of crystal. The energy maps corresponding to the configurations of Fig. 3 d and f are shown in Fig. 4 c and d, respectively. The elastic energy of the crystal decreases upon separation of the mentioned dislocations. Therefore, 30° PDs with equal screw components of Burgers vectors would repulse each other within the interaction radius. One of them would advance and glide toward the 3C-SiC surface, while the other one would stop at the disconnection of the slip plane created by the SF left by the former dislocation. As a result, " λ "-shaped SF intersection would be formed with the exclusion of only one stacking fault from extension.

ARTICLE

CrystEngComm

The results obtained in this study give an insight to the exploitation of the annihilation mechanism to reduce the concentration of stacking faults in epitaxial 3C-SiC layers on Si(001) substrates. Efficient SF elimination may be achieved by manipulation of stress in the 3C-SiC layers during deposition e.g. by optimization of temperature at different deposition stages, to limit the propagation of the 30° partial dislocations leading the SFs. Attenuation of stress would also reduce the generation of partial dislocations and associated stacking faults at the 3C-SiC surface and their motion to the bulk, thus contributing to the minimization of SF concentration.

Conclusions

Published on 04 January 2021. Downloaded by Universita di Catania on 1/7/2021 5:22:10 PM

In conclusion, we have studied the mechanism of the annihilation and the formation of the intersection patterns of stacking faults in 3C-SiC layers epitaxially grown on Si(001) substrates by MD simulations. We have shown that the annihilation of stacking faults lying in opposite {111} planes, during 3C-SiC layer growth is determined by the motion and interaction of 30° Shockley partial dislocations leading the SFs, under slightly compressive strain condition. The key parameters characterizing the SF annihilation process are the distance between the leading PDs and the mutual orientation of their Burgers vectors. 30° partials with opposite screw components of Burgers vectors interact attractively at small distances (~ 15 nm or less) forming a Lomer-Cottrell lock at the "inverted V" SF intersection. As a result, two SFs are annihilated. On the other hand, " λ "-shaped SF intersection with annihilation of only one stacking fault is obtained when SF leading dislocations are too far apart (more than ~ 15 nm) and do not interact efficiently or they have equal screw components of Burgers vectors causing repulsion between them. Obtained results have an important implication for the elaboration of the improved methods of the reduction of SF concentrations in epitaxial 3C-SiC layers on Si(001) substrates for power device application

Author contributions

Conceptualization, A.S. and A.M.; funding acquisition, F.L.V. and L.M.; investigation, A.S.; methodology, A.S., A.M. and L.B.; project administration, F.L.V. and L.M.; resources, M.Z., C.B., M.M. and D.C.; software, A.S. and L.B.; supervision, L.M.; writing – original draft, A.S.; writing – review and editing, A.M, L.B., M.Z. and L.M.

Conflicts of interest

There are no conflicts to declare.

Acknowledgements

Authors acknowledge EU for funding the CHALLENGE project (3C-SiC Hetero-epitaxiALLy grown on silicon compliancE substrates and 3C-SiC substrates for sustaiNable wide-band-Gap power devices) within the EU's H2020 framework program for research and innovation under grant agreement n. 720827.

References

- 1 D. J. Young, J. Du, C. A. Zorman and W. H. Ko, *IEEE Sensors Journal*, 2004, **4**, 464.
- 2 S. E. Saddow and A. Agarwal, *Advances in Silicon Carbide Processing and Applications*, Artech House Publisher, Boston, 2004.
- 3 T. J. Fawcett and J. T. Wolan, *Appl. Phys. Lett.*, 2006, **89**, 182102.
- 4 V. V. Afanasev, M. Bassler, G. Pensl and M. Schulz, *Physica Status Solidi A*, 1997, **162**, 321.
- 5 M. Mehregany, C. A. Zorman, S. Roy, A. J. Fleischman, C.-H. Wu and N. Rajan, *Int. Mater. Reviews*, 2000, **45**, 85.
- M. Ruff, H. Mitlehner and R. Helbig, *IEEE Trans. Electron Devices*, 1994, 41, 1040.
- 7 F. Giannazzo, G. Greco, S. D. Franco, P. Fiorenza, I. Deretzis, A. L. Magna, C. Bongiorno, M. Zimbone, F. L. Via, M. Zielinski and F. Roccaforte, *Adv. Electr. Mater.*, 2020, 6, 1901171.
- 8 X. Song, J. F. Michaud, F. Cayrel, M. Zielinski, M. Portail, T. Chassagne, E. Collard and D. Alquier, *Appl. Phys. Lett.*, 2010, 96, 142104.
- 9 E. Scalise, L. Barbisan, A. Sarikov, F. Montalenti, L. Miglio and A. Marzegalli, *J. Mater. Chem. C*, 2020, **8**, 8380.
- F. La Via, A. Severino, R. Anzalone, C. Bongiorno, G. Litrico, M. Mauceri, M. Schoeler, P. Schuh and P. Wellmann, *Mater. Sci. in Semicond. Proc.*, 2018, **78**, 57.
- M. Zimbone, E. G. Barbagiovanni, C. Bongiorno, C. Calabretta, L. Calcagno, G. Fisicaro, A. L. Magna and F. L. Via, *Cryst. Growth Des.*, 2020, **20**, 3104.
- 12 G. Fisicaro, C. Bongiorno, I. Deretzis, F. Giannazzo, F. L. Via, F. Roccaforte, M. Zielinski, M. Zimbone and A. La Magna, *Appl. Phys. Rev.*, 2020, **7**, 021402.
- 13 H. Nagasawa, R. Gurunathan and M. Suemitsu, *Mater. Sci. Forum*, 2015, **821-823**, 108.
- 14 H. Nagasawa, K. Yagi and T. Kawahara, *J. Cryst. Growth*, 2002, **237-239**, 1244.
- 15 Y. Sun, S. Izumi, S. Sakai, K. Yagi and H. Nagasawa, *Physica Status Solidi B*, 2012, **249**, 555.
- G. D'Arrigo, A. Severino, G. Milazzo, C. Bongiorno, N. Piluso, G. Abbondanza, M. Mauceri, G. Condorelli and F. La Via, *Mater. Sci. Forum*, 2010, 645-648, 135.
- 17 M. Zimbone, M. Zielinski, C. Bongiorno, C. Calabretta, R. Anzalone, S. Scalese, G. Fisicaro, A. La Magna, F. Mancarella and F. La Via, *Materials*, 2019, **12**, 3407.
- 18 H. von Känel, L. Miglio, D. Crippa, T. Kreiliger, M. Mauceri, M. Puglisi, F. Mancarella, R. Anzalone, N. Piluso and F. La Via, *Mater. Sci. Forum*, 2015, **821-823**, 193.
- 19 M. Meduña, T. Kreiliger, I. Prieto, M. Mauceri, M. Puglisi, F. Mancarella, F. La Via, D. Crippa, L. Miglio and H. von Känel, *Mater. Sci. Forum*, 2016, 858, 147.
- 20 V. Papaioannow, P. Komninou, G. P. Dimitrakopulos, K. Zekentes, B. Pecz, T. Karakostas and J. Stoemenos, *Diamond and Related Mater.*, 1997, 6, 1362.
- 21 J. Yamasaki, S. Inamoto, Y. Nomura, H. Tamaki and N. Tanaka, *J. Phys. D: Appl. Phys.*, 2012, **45**, 494002.
- 22 S. Plimpton, J. Comput. Phys., 1995, 117, 1.
- 23 P. Vashishta, R. K. Kalia, A. Nakano and J. P. Rino, J. Appl. Phys., 2007, 101, 103515.
- 24 A. Sarikov, A. Marzegalli, L. Barbisan, E. Scalise, F. Montalenti and L. Miglio, *Modell. Simul. Mater. Sci. Eng.*, 2020, 28, 015002.
- 25 A. Stukowski, Model. Simul. Mater. Sci. Eng., 2012, 18, 015012.
- 26 J. P. Hirth and J. Lotte, *Theory of Dislocations*, Krieger Publishing Company, Malabar, 1982.

View Article Online DOI: 10.1039/D0CE01613F

CrystEngComm Accepted Manuscript

CrystEngComm

DOI: 10.1039/D0CE01613F

- 27 W. Cai, V. V. Bulatob, J. Chang, J. Li and S. Tip, Philos. Mag., 2003, 83, 539.
- 28 A. Sarikov, A. Marzegalli, L. Barbisan, F. Montalenti and L. Miglio, Materials, 2019, 12, 3027.
- 29 D. Méndez, A. Aouni, F. M. Morales, F. J. Pacheco, D. Araújo, E. Bustarret, G. Ferro and Y. Monteil, Physica Status Solidi A, 2005, 202, 561.
- 30 A. Taylor and R. M. Jones, Silicon Carbide A High Temperature Semiconductor, Pergamon Press, London, 1960.
- 31 W. M. Yim and R. J. Paff, J. Appl. Phys., 1974, 45, 1456.
- 32 B. Yang, H. Zhuang, J. Li, N. Huang, L. Liu, K. Tai and X. Jiang, CrystEngComm, 2016, 18, 6817.
- 33 W. Wegscheider and S. Cerva, J. Vac. Sci. Technol. B, 1993, **11**, 1056.
- 34 E. Scalise, A. Marzegalli, F. Montalenti and L. Miglio, Phys. *Rev. Appl.*, 2019, **12**, 021002.